

CX3SM AT CRYSTAL

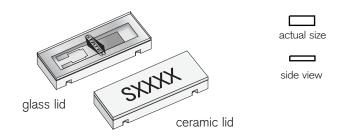
9.6 MHz to 250 MHz

Low Profile Miniature Surface Mount AT Quartz Crystal

Fundamental Mode: 9.6 MHz - 70 MHz Third Overtone Mode: 48 MHz - 250 MHz

DESCRIPTION

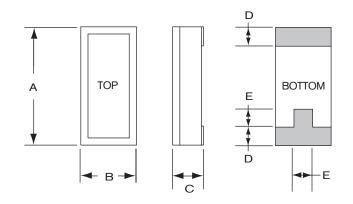
STATEK's miniature CX3SM AT crystals in leadless ceramic packages are designed for surface mounting on printed circuit boards or hybrid substrates. These crystals are low profile and have a small land pattern.



FEATURES

- Designed for surface mount applications using infrared, vapor phase, or epoxy mount techniques.
- Low profile (less than 1.5 mm available) hermetically sealed ceramic package
- Excellent aging characteristics
- Available with glass or ceramic lid
- High shock and vibration resistance
- Custom designs available
- Full military testing available
- Designed and manufactured in the USA

PACKAGE DIMENSIONS



APPLICATIONS

Medical

Monitoring Equipment

Industrial, Computer & Communications

- Instrumentation
- Down-hole Data Recorder
- Engine Control
- Handheld Inventory Control
- Telemetry

Military & Aerospace

- Communications
- Smart Munitions
- Timing Devices
- Surveillance Devices

	TYPI	CAL	MAX	IMUM
DIM	inches	mm	inches	mm
Α	0.263	6.68	0.270	6.86
В	0.097	2.46	0.104	2.64
С	-	-	see below	
D	0.052	1.32	0.058	1.47
Е	0.030	0.76	0.035	0.89

THICKNESS (DIM C) MAXIMUM

	GLASS LID		CERAMIC LID	
	inches	mm	inches	mm
SM1	0.053	1.35	0.067	1.70
SM2/SM4	0.055	1.40	0.069	1.75
SM3/SM5	0.058	1.47	0.072	1.83

10120 - Rev D



SPECIFICATIONS

Specifications are typical at 25°C unless otherwise noted. Specifications are subject to change without notice.

Fundamental Frequency	<u>10 MHz</u>	32 MHz	<u>155.52 MHz</u>
Motional Resistance R_1 (Ω)	60	25	10
Motional Capacitance C_1 (fF)	2.8	6.2	4.0
Quality Factor Q (k)	95	30	30
Shunt Capacitance C ₀ (pF)	1.4	2.3	2.3

Calibration Tolerances¹ ± 100 ppm, or tighter as required

Load Capacitance² 20 pF for f ≤ 50 MHz

10 pF for f > 50 MHz

Drive Level 500 μ W MAX for f \leq 50 MHz

 $200~\mu\text{W}$ MAX for f >50~MHz

Frequency-Temperature

Stability^{1,3}

± 50 ppm to ± 10 ppm (Commercial) ± 100 ppm to ± 20 ppm (Industrial)

± 100 ppm to ± 30 ppm (Military)

Aging, first year⁴ 5 ppm MAX (less than 1 ppm available)

Shock, survival⁵ 3,000 g, 0.3 ms, 1/2 sine

Vibration, survival⁶ 20 g, 10-2,000 Hz swept sine

Operating Temp. Range -10°C to +70°C (Commercial)

-40°C to +85°C (Industrial) -55°C to +125°C (Military)

Storage Temp. Range -55°C to +125°C

Max Process Temperature 260°C for 20 sec.

1. Other tolerances available. Contact factory.

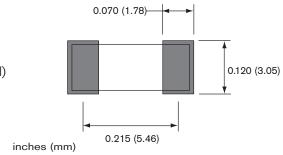
- Unless specified otherwise.
- Does not include calibration tolerance. The characteristics of the frequency stability over temperature follow that of the AT thickness-shear mode.
- 10 ppm MAX for frequencies below 40 MHz. For tighter tolerances and higher frequencies contact factory.
- 5. Higher shock version available.
- 6. Per MIL-STD-202G, Method 204D, Condition D. Random vibration testing also available.

TERMINATIONS

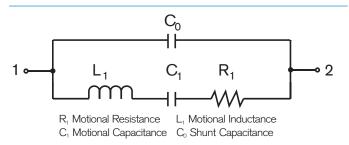
<u>Designation</u>	<u>Termination</u>
SM1	Gold Plated (Lead Free)
SM2	Solder Plated
SM3	Solder Dipped
SM4	Solder Plated (Lead Free)
SM5	Solder Dipped (Lead Free)

Max Process Temperature 260°C for 20 sec.

SUGGESTED LAND PATTERN



EQUIVALENT CIRCUIT



PACKAGING OPTIONS

- Tray Pack
- 16mm tape, 7" or 13" reels
 Per EIA 481 (see Tape and Reel data sheet 10109)

HOW TO ORDER CX3SM AT CRYSTALS

